

Listing of the Claims:

1. – 7. (Cancelled)

8. (Previously Presented): A component placement device comprising:
an elongated transport device that is configured to transport a first substrate in a transport direction parallel to the transport device;
at least one component feeder that is located along a longitudinal side of the transport device;
at least one component pick-and-place unit that is configured to: (a) pick-up a component from the at least one component feeder; and (b) place the component on the first substrate supported by the elongated transport device; and
at least one substrate support that is configured to support a second substrate, wherein the at least one substrate support is positioned on only one longitudinal side of the transport device that is opposite from the longitudinal side at which the component feeder is located, and the at least one substrate support has a longitudinal direction that extends perpendicular to the transport direction,
wherein the at least one component pick-and-place unit is further configured to: (c) pick-up a component from the at least one component feeder; and (d) move the component over the elongated transport device to place the component on the second substrate supported by the substrate support.

9. (Previously Presented): The component placement device as claimed in claim 8, wherein the substrate support is detachably connected to the component placement device.

10. (Previously Presented): The component placement device as claimed in claim 8, wherein the substrate support comprises drive means configured to transport the second substrate in a feeding direction that extends transverse to the transport direction.

11. (Previously Presented): The component placement device as claimed in claim 8, wherein the transport device comprises at least one guide profile that extends parallel to the transport direction,

wherein the at least one guide profile is connected to the substrate support, and

wherein the at least one guide profile is configured to be moved together with the substrate support in a direction that extends transverse to the transport direction.

12. (Previously Presented): The component placement device as claimed in claim 10, wherein the substrate support comprises two guides that extend parallel to each other and transverse to the transport direction.

13. (Previously Presented): The component placement device as claimed in claim 11, wherein the substrate support comprises two guides that extend parallel to each other and transverse to the transport direction.

14. (Previously Presented): The component placement device as claimed in claim 12, wherein a distance between the guides is adjustable.

15. (Previously Presented): The component placement device as claimed in claim 13, wherein a distance between the guides is adjustable.

16. (Previously Presented): The component placement device as claimed in claim 8, wherein the substrate support is configured to be moved vertically from a position parallel to the transport device to a position underneath the transport device.

17. (Previously Presented): The component placement device as claimed in claim 10, wherein the substrate support is configured to be moved vertically from a position parallel to the transport device to a position underneath the transport device.

18. (Previously Presented): The component placement device as claimed in claim 11, wherein the substrate support is configured to be moved vertically from a position parallel to the transport device to a position underneath the transport device.

19. (Previously Presented): The component placement device as claimed in claim 8, wherein the at least one substrate support is configured to move the second substrate in a direction perpendicular to the transport direction.

20. (Previously Presented): A component placement device comprising:

an elongated transport device that is configured to transport a first substrate in a transport direction parallel to the transport device;

a component feeder that is located only on one longitudinal side of the transport device;

at least one component pick-and-place unit that is configured to: (a) pick-up a component from the at least one component feeder; and (b) place the component on the first substrate supported by the elongated transport device; and

at least one substrate support that is configured to support a second substrate, wherein the at least one substrate support is positioned on only one longitudinal side of the transport device that is opposite from the longitudinal side at which the component feeder is located, and the at least one substrate support has a longitudinal direction that extends perpendicular to the transport device,

wherein the at least one component pick-and-place unit is configured to: (c) pick-up a component from the at least one component feeder; and (d) move the component over the elongated transport device to place the component on the second substrate supported by the substrate support.